

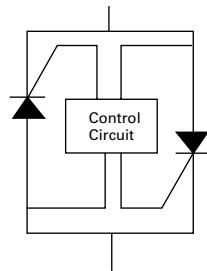
PLED Ultra Low Holding Current Series



Description

This PLED ultra-low holding current series exhibits a low holding current parameter that makes it compatible with LED lighting strings. The series provide a switching electronic characteristics for an fluorescent tube replacement by an LED string. It helps to make the Fluorescent ballast and LED string compatible with each other. This ensures the ballast will be able to activate the LED string; especially for those ballast that need a high voltage output detection during ignition. The PLED ultra-low I_H makes the LED driver widely used in the output of fluorescent tubes a compatible direct replacement for indoor and outdoor LED lighting strings.

Schematic Symbol



Features & Benefits

- Fast switching
- Automatically resets after power cycle
- Available in low profile, Standard DO-214AA packages
- IEC-61000-4-2 ESD 30kV (Air), 30kV (Contact)
- ESD protection of data lines in accordance with IEC 61000-4-2 (IEC 801-2)
- Compatible with industrial lighting environments
- RoHS compliant and halogen-free


Electrical Characteristics (All parameters are measured at $T_A=25^\circ\text{C}$ unless otherwise noted)

Part Number	Marking	V_{BR} Breakdown		V_{DRM}	I_H	I_S	$V_T @ I_T = 1$ Amp	I_o^1	Critical rate of rise dV/dt
		Volts		Volts	mAmps	mAmps	Volts	Amps	Volts
		Min	Max	Min	Max	Max	Max	Max	Min
PLED64S	PL64	58	71	56	21	800	2	1.0	250V/ μs
PLED70S	PL70	65	81	63	21	800	2	1.0	250V/ μs
PLED90S	PL90	75	90	73	21	800	2	1.0	250V/ μs
PLED110S	PL110	90	120	87	21	800	2	1.0	250V/ μs
PLED130S	PL130	120	149	116	21	800	2	1.0	250V/ μs
PLED150S	PL150	136	167	132	21	800	2	1.0	250V/ μs
PLED180S	PL180	170	203	165	21	800	2	1.0	250V/ μs
PLED230S	PL230	190	240	184	21	800	2	1.0	250V/ μs
PLED260S	PL260	220	274	213	21	800	2	1.0	250V/ μs
PLED310S	PL310	275	330	267	21	800	2	1.0	250V/ μs
PLED350S	PL350	320	380	310	21	800	2	1.0	250V/ μs
PLED380S	PL380	350	430	340	21	800	2	1.0	250V/ μs
PLED450S ²	PL450	410	495	397	21	800	2	1.0	250V/ μs
PLED480S ²	PL480	450	600	436	21	800	2	1.0	250V/ μs

note:

1. I_o - Operation current tested @ aluminum boards, ambient temp 85°C
2. PLED450S and PLED480S are still under developed, please contact local sales representative for further information

Thermal Considerations

Package	Symbol	Parameter	Value	Unit
 DO-214	T_J	Operating Junction Temperature Range	-40 to +125	°C
	T_S	Storage Temperature Range	-65 to +150	°C
	$R_{\theta JA}$	Thermal Resistance: Junction to Ambient	90 ¹ 40 ²	°C/W

Notes:

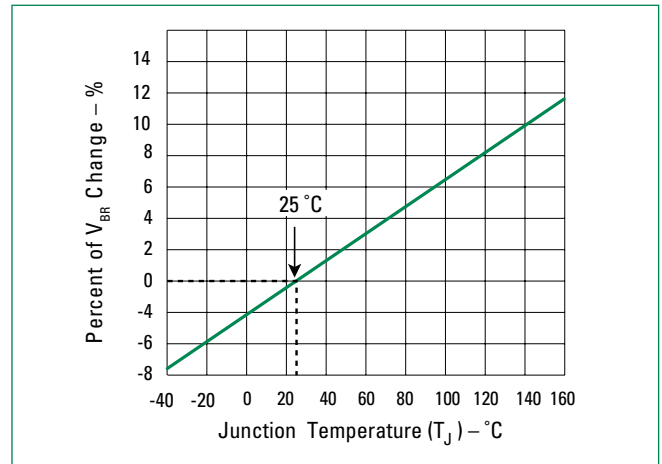
- Standard FR-4 PCB with Copper Pads (Recommended Size)
- Aluminum PCB

Thickness: 1.6mm
 Grade: 1-2 W/mK Thermal Conductivity
 Trace thickness: 2 oz
 Insulation layer thickness: 215 um
 Solder Pad Dimensions: 2.0mm x 2.8mm (Recommended Size)

V-I Characteristics



V_{BR} vs. Junction Temperature

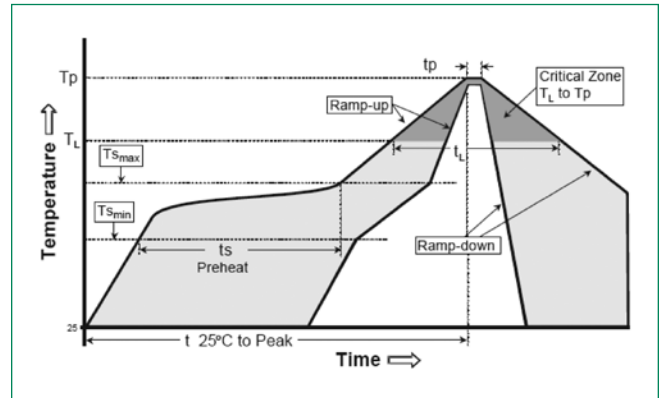


Normalized DC Holding Current vs. Case Temperature



Soldering Parameters

Reflow Condition		Pb – Free assembly
Pre Heat	- Temperature Min ($T_{s(min)}$)	150°C
	- Temperature Max ($T_{s(max)}$)	200°C
	- Time (min to max) (t_s)	60 – 180 secs
Average ramp up rate (Liquidus Temp (T_L) to peak)		3°C/second max
$T_{s(max)}$ to T_L - Ramp-up Rate		3°C/second max
Reflow	- Temperature (T_L) (Liquidus)	217°C
	- Temperature (t_L)	60 – 150 seconds
Peak Temperature (T_p)		260 ^{+0/-5} °C
Time within 5°C of actual peak Temperature (t_p)		30 seconds
Ramp-down Rate		6°C/second max
Time 25°C to peak Temperature (T_p)		8 minutes max
Do not exceed		260°C



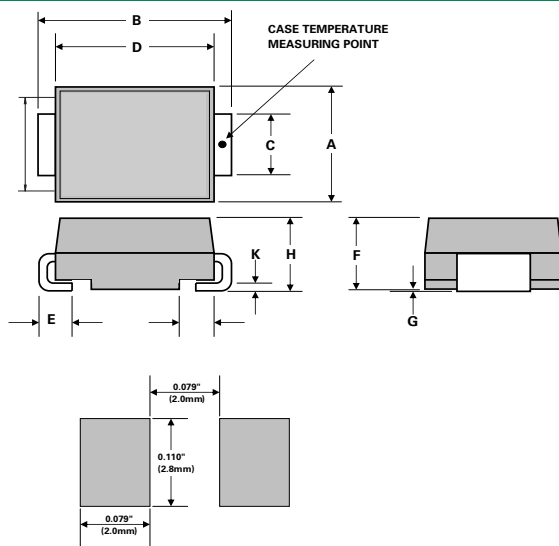
Physical Specifications

Terminal Material	Copper Alloy
Terminal Finish	100% Matte Tin Plated
Body Material	UL Recognized compound meeting flammability rating V-0.

Environmental Specifications

High Temperature Voltage Blocking	MIL-STD-750: Method 1040, Condition A 80% min V_{DRM} (VAC-peak), 125°C, 1008 hours
Temperature Cycling	MIL-STD-750: Method 1051, -55°C to 150°C, 15-minute dwell, 1000 cycles
Biased Temperature & Humidity	EIA/JEDEC: JESD22-A101 52VDC, 85°C, 85%RH, 1008 hours
Thermal Shock	MIL-STD-750: Method 1056 0°C to 100°C, 5-minute dwell, 10-second transfer, 10 cycles
Resistance to Solder Heat	MIL-STD-750: Method 2031 260°C, 10 seconds
Moisture Sensitivity Level	85%RH, +85°C, 168 hours, 3 reflow cycles (+260°C peak). JEDEC-J-STD-020, Level 1

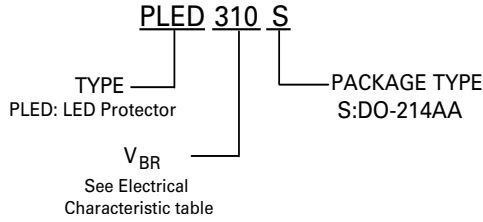
Dimensions - DO-214 AA Package



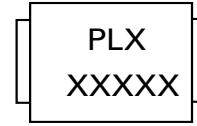
Recommended solder pad layout
(Reference Only)

Dimensions	Inches		Millimeters	
	Min	Max	Min	Max
A	0.130	0.156	3.30	3.95
B	0.201	0.220	5.10	5.60
C	0.077	0.087	1.95	2.20
D	0.159	0.181	4.05	4.60
E	0.030	0.063	0.75	1.60
F	0.075	0.096	1.90	2.45
G	0.002	0.008	0.05	0.20
H	0.077	0.104	1.95	2.65
K	0.006	0.016	0.15	0.41

Part Numbering System



Part Marking System

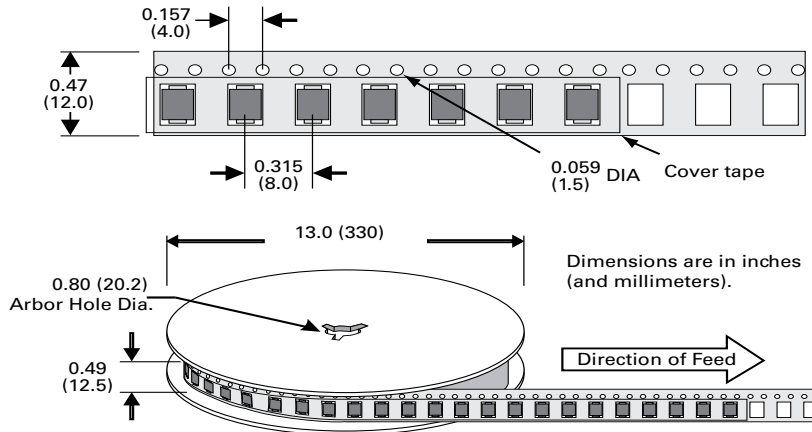


Packaging

Package	Description	Packaging Quantity	Industry Standard
S	DO-214AA	2500	EIA-481-1

DO-214 Embossed Carrier Reel Pack (RP)

Meets all EIA-481-1 Standards



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